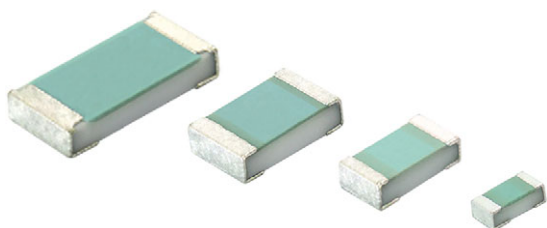


Precision Thin Film Chip Resistors



FEATURES

- IECQ-CECC approved to EN 140401-801
- Low TCR: ± 10 ppm/K to ± 25 ppm/K
- Precision tolerance of resistance: $\pm 0.1\%$ and $\pm 0.25\%$
- Superior overall stability: class 0.1 and 0.25
- Sulfur resistance verified according to ASTM B 809
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE
GREEN
(5-2008)

Thin film flat chip resistors combine the proven reliability of the professional products with an advanced level of precision and stability. Therefore they are perfectly suited for applications in the fields of test and measurement equipment together with industrial and medical electronics.

APPLICATIONS

- Industrial equipment
- Test and measuring equipment
- Telecommunication
- Medical equipment

TECHNICAL SPECIFICATIONS				
DESCRIPTION	MCS 0402	MCT 0603	MCU 0805	MCA 1206
Imperial size	0402	0603	0805	1206
Metric size code	RR1005M	RR1608M	RR2012M	RR3216M
Resistance range	100 Ω to 221 k Ω	39 Ω to 511 k Ω	39 Ω to 1.5 M Ω	39 Ω to 2 M Ω
Resistance tolerance	$\pm 0.25\%$; $\pm 0.1\%$			
Temperature coefficient	± 25 ppm/K; ± 15 ppm/K; ± 10 ppm/K			
Rated dissipation, $P_{70}^{(1)}$	0.063 W	0.100 W	0.125 W	0.250 W
Operating voltage, U_{max} AC _{RMS} /DC	50 V	75 V	150 V	200 V
Permissible film temperature, $\vartheta_{F max}^{(1)}$	125 $^{\circ}$ C			
Operating temperature range	-55 $^{\circ}$ C to 125 $^{\circ}$ C			
Internal thermal resistance $^{(1)}$	90 K/W	63 K/W	38 K/W	32 K/W
Permissible voltage against ambient (insulation): 1 min; U_{ins}	75 V	100 V	200 V	300 V
Failure rate: FIT _{observed}	$\leq 0.1 \times 10^{-9}/h$			

Note

⁽¹⁾ Please refer to APPLICATION INFORMATION below

APPLICATION INFORMATION

When the resistor dissipates power, a temperature rise above the ambient temperature occurs, dependent on the thermal resistance of the assembled resistor together with the printed circuit board. The rated dissipation applies only if the permitted film temperature is not exceeded.

These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime.



MAXIMUM RESISTANCE CHANGE AT RATED DISSIPATION			
OPERATION MODE		PRECISION	STANDARD
Rated dissipation, P_{70}	MCS 0402	0.016 W	0.063 W
	MCT 0603	0.032 W	0.100 W
	MCU 0805	0.050 W	0.125 W
	MCA 1206	0.100 W	0.250 W
Operating voltage, $U_{\max}$. AC _{RMS} /DC	MCS 0402	12.5 V	50 V
	MCT 0603	25 V	75 V
	MCU 0805	35 V	150 V
	MCA 1206	50 V	200 V
Operating temperature range		-10 °C to 85 °C	-55 °C to 125 °C
Permissible film temperature, $\vartheta_F \max.$		85 °C	125 °C
Max. resistance change at P_{70} for resistance range, $ \Delta R/R $ after:	MCS 0402	100 Ω to 221 k Ω	100 Ω to 221 k Ω
	MCT 0603	39 Ω to 511 k Ω	39 Ω to 511 k Ω
	MCU 0805	39 Ω to 1.5 M Ω	39 Ω to 1.5 M Ω
	MCA 1206	39 Ω to 2 M Ω	39 Ω to 2 M Ω
	1000 h	≤ 0.05 %	≤ 0.1 %
	8000 h	≤ 0.1 %	≤ 0.25 %
	225 000 h	≤ 0.25 %	≤ 0.5 %

Note

- The presented operation modes do not refer to different types of resistors, but actually show examples of different loads, that lead to different film temperatures and different achievable load-life stability (drift) of the resistance value. A suitable low thermal resistance of the circuit board assembly must be safeguarded in order to maintain the film temperature of the resistors within the specified limits. Please consider the application note "Thermal Management in Surface-Mounted Resistor Applications" (www.vishay.com/doc?28844) for information on the general nature of thermal resistance

TEMPERATURE COEFFICIENT AND RESISTANCE RANGE ⁽¹⁾				
TYPE / SIZE	TCR	TOLERANCE	RESISTANCE	E-SERIES
MCS 0402	± 25 ppm/K	± 0.25 %	100 Ω to 221 k Ω	E24; E192
		± 0.1 %	100 Ω to 221 kΩ	
	± 15 ppm/K	± 0.25 %	100 Ω to 150 k Ω	
		± 0.1 %	100 Ω to 150 kΩ	
	± 10 ppm/K	± 0.25 %	100 Ω to 130 k Ω	
		± 0.1 %	100 Ω to 130 kΩ	
MCT 0603	± 25 ppm/K	± 0.25 %	39 Ω to 511 k Ω	
		± 0.1 %	47 Ω to 511 kΩ	
	± 15 ppm/K	± 0.25 %	39 Ω to 332 k Ω	
		± 0.1 %	47 Ω to 332 kΩ	
	± 10 ppm/K	± 0.25 %	39 Ω to 221 k Ω	
		± 0.1 %	47 Ω to 221 kΩ	
MCU 0805	± 25 ppm/K	± 0.25 %	39 Ω to 1.5 M Ω	
		± 0.1 %	47 Ω to 1.5 MΩ	
	± 15 ppm/K	± 0.25 %	39 Ω to 1 M Ω	
		± 0.1 %	47 Ω to 1 MΩ	
	± 10 ppm/K	± 0.25 %	39 Ω to 511 k Ω	
		± 0.1 %	47 Ω to 511 kΩ	
MCA 1206	± 25 ppm/K	± 0.25 %	39 Ω to 2 M Ω	
		± 0.1 %	47 Ω to 2 MΩ	
	± 15 ppm/K	± 0.25 %	39 Ω to 1.5 M Ω	
		± 0.1 %	47 Ω to 1.5 MΩ	
	± 10 ppm/K	± 0.25 %	39 Ω to 1 M Ω	
		± 0.1 %	47 Ω to 1 MΩ	

Notes

- Resistance ranges printed in bold are preferred TCR / tolerance combinations with optimized availability

⁽¹⁾ For the approved IECQ-CECC resistance range, please refer to www.vishay.com/doc?28945



PACKAGING

TYPE / SIZE	CODE	QUANTITY	PACKAGING STYLE	WIDTH	PITCH	PACKAGING DIMENSIONS
MCS 0402	E5	5000	Paper tape acc. IEC 60286-3, Type 1a	8 mm	2 mm	Ø 180 mm/7"
	E0	10 000				Ø 180 mm/7"
MCT 0603	P5	5000			4 mm	Ø 180 mm/7"
	PW	20 000				Ø 330 mm/13"
MCU 0805	P5	5000				Ø 180 mm/7"
	PW	20 000				Ø 330 mm/13"
MCA 1206	P5	5000				Ø 180 mm/7"

PART NUMBER AND PRODUCT DESCRIPTION

Part Number: MCT06030D4641BPW00

M	C	T	0	6	0	3	0	D	4	6	4	1	B	P	W	0	0
TYPE / SIZE			VERSION			TCR			RESISTANCE			TOLERANCE			PACKAGING		
MCS0402 MCT0603 MCU0805 MCA1206			0 = neutral			F = ± 10 ppm/K E = ± 15 ppm/K D = ± 25 ppm/K			3 digit value 1 digit multiplier Multiplier 9 = *10 ⁻¹ 0 = *10 ⁰ 1 = *10 ¹ 2 = *10 ² 3 = *10 ³ 4 = *10 ⁴			B = ± 0.1 % C = ± 0.25 %			E5 E0 P5 PW		

Product Description: MCT 0603-25 0.1 % PW 4K64

MCT	0603	-25	0.1 %	PW	4K64
TYPE	SIZE	TCR	TOLERANCE	PACKAGING	RESISTANCE
MCS MCT MCU MCA	0402 0603 0805 1206	± 10 ppm/K ± 15 ppm/K ± 25 ppm/K	± 0.1 % ± 0.25 %	E5 E0 P5 PW	4K64 = 4.64 kΩ 50R1 = 50.1 Ω

Note

- Products can be ordered using either the PART NUMBER or PRODUCT DESCRIPTION



DESCRIPTION

Production is strictly controlled and follows an extensive set of instructions established for reproducibility. A homogeneous film of metal alloy is deposited on a high grade ceramic substrate (Al_2O_3) and conditioned to achieve the desired temperature coefficient. Specially designed inner contacts are deposited on both sides. A special laser is used to achieve the target value by smoothly fine trimming the resistive layer without damaging the ceramics. A further conditioning is applied in order to stabilize the trimming result. The resistor elements are covered by a protective coating designed for electrical, mechanical and climatic protection. The terminations receive a final pure matte tin on nickel plating.

The result of the determined production is verified by an extensive testing procedure and optical inspection performed on 100 % of the individual chip resistors. This includes full screening for the elimination of products with potential risk of early field failures. Only accepted products are laid directly into the paper tape in accordance with **IEC 60286-3 Type 1a** ⁽¹⁾.

ASSEMBLY

The resistors are suitable for processing on automatic SMD assembly systems and for automatic soldering using wave, reflow or vapor phase. The encapsulation is resistant to all cleaning solvents commonly used in the electronics industry, including alcohols, esters and aqueous solutions. The suitability of conformal coatings, potting compounds and their processes, if applied, shall be qualified by appropriate means to ensure the long-term stability of the whole system.

The resistors are RoHS-compliant, the pure matte tin plating provides compatibility with lead (Pb)-free and lead-containing soldering processes. Solderability is specified for 2 years after production or requalification. The permitted storage time is 20 years. The immunity of the plating against tin whisker growth has been proven under extensive testing.

MATERIALS

Vishay acknowledges the following systems for the regulation of hazardous substances:

- IEC 62474, Material Declaration for Products of and for the Electrotechnical Industry, with the list of declarable substances given therein ⁽²⁾
- The Global Automotive Declarable Substance List (GADSL) ⁽³⁾
- The REACH regulation (1907/2006/EC) and the related list of substances with very high concern (SVHC) ⁽⁴⁾ for its supply chain

Notes

- ⁽¹⁾ The quoted IEC standards are also released as EN standards with the same number and identical contents
- ⁽²⁾ The IEC 62474 list of declarable substances is maintained in a dedicated database, which is available at <http://std.iec.ch/iec62474>
- ⁽³⁾ The Global Automotive Declarable Substance List (GADSL) is maintained by the American Chemistry Council and available at www.gadsl.org
- ⁽⁴⁾ The SVHC list is maintained by the European Chemical Agency (ECHA) and available at <http://echa.europa.eu/candidate-list-table>

The products do not contain any of the banned substances as per IEC 62474, GADSL, or the SVHC list, see www.vishay.com/how/leadfree.

Hence the products fully comply with the following directives:

- 2000/53/EC End-of-Life Vehicle Directive (ELV) and Annex II (ELV II)
- 2011/65/EU Restriction of the Use of Hazardous Substances Directive (RoHS) with amendment 2015/863/EU
- 2012/19/EU Waste Electrical and Electronic Equipment Directive (WEEE)

Vishay pursues the elimination of conflict minerals from its supply chain, see the Conflict Minerals Policy at www.vishay.com/doc?49037.

APPROVALS

Where applicable, the resistors are approved within the IECQ-CECC Quality Assessment System for Electronic Components to the detail specification **EN 140401-801** which refers to **EN 60115-1**, **EN 60115-8** and the variety of environmental test procedures of the **IEC 60068** ⁽¹⁾ series.

Conformity is attested by the use of the **CECC** logo () as the mark of conformity on the package label.

Vishay Beyschlag has achieved “**Approval of Manufacturer**” in accordance with **IECQ 03-1**. The release certificate for “**Technology Approval Schedule**” in accordance with **CECC 240001** based on **IECQ 03-3-1** is granted for the Vishay Beyschlag manufacturing process.

RELATED PRODUCTS

Resistors are available with established reliability in accordance with EN 140401-801 version E. Please refer to the special datasheet (www.vishay.com/doc?28744) for information on failure rate level, available resistance ranges and order codes.

For more information about products with higher rated power and higher operation temperature please refer to the Professional Thin Film Chip Resistor datasheet (www.vishay.com/doc?28705).

Precision chip resistor arrays may be used in voltage divider applications or precision amplifiers where close matching between multiple resistors is necessary. Please refer to the ACAS 0612 - Precision datasheet (www.vishay.com/doc?28751).



FUNCTIONAL PERFORMANCE



Derating - Standard Operation



Derating - Precision Operation



In accordance with IEC 60195

Current Noise Voltage Ratio



TESTS AND REQUIREMENTS

All tests are carried out in accordance with the following specifications:

EN 60115-1, generic specification

EN 60115-8, sectional specification

EN 140401-801, detail specification

IEC 60068-2-xx, test methods

The components are approved under the IECQ-CECC quality assessment system for electronic components.

The parameters stated in the Test Procedures and Requirements table are based on the required tests and permitted limits of EN 140401-801. The table presents only the most important tests, for the full test schedule refer to the documents listed above. However, some additional tests and a number of improvements against those minimum requirements have been included.

The testing also covers most of the requirements specified by EIA/ECA-703 and JIS-C-5201-1.

The tests are carried out under standard atmospheric conditions in accordance with IEC 60068-1, 4.3, whereupon the following values are applied:

Temperature: 15 °C to 35 °C

Relative humidity: 25 % to 75 %

Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar)

A climatic category LCT / UCT / 56 is applied, defined by the lower category temperature (LCT), the upper category temperature (UCT), and the duration of exposure in the damp heat, steady state test (56 days).

The components are mounted for testing on printed circuit boards in accordance with EN 60115-8, 2.4.2, unless otherwise specified.

TEST PROCEDURES AND REQUIREMENTS					
EN 60115-1 CLAUSE	IEC 60068-2 (1) TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR)	
				STABILITY CLASS 0.1	STABILITY CLASS 0.25
			Stability for product types:		
			MCS 0402	100 Ω to 10 k Ω	> 10 k Ω to 221 k Ω
			MCT 0603	100 Ω to 10 k Ω	39 Ω to < 100 Ω ; > 10 k Ω to 511 k Ω
			MCU 0805	100 Ω to 47.5 k Ω	39 Ω to < 100 Ω ; > 47.5 k Ω to 1.5 M Ω
			MCA 1206	47 Ω to 332 k Ω	39 Ω to < 47 Ω ; > 332 k Ω to 2 M Ω
4.5	-	Resistance	-	$\pm 0.1 \% R$; $\pm 0.25 \% R$	
4.8	-	Temperature coefficient	At (20 / - 10 / 20) °C and (20 / 85 / 20) °C	± 25 ppm/K; ± 15 ppm/K; ± 10 ppm/K	-
			At (20 / - 55 / 20) °C and (20 / 125 / 20) °C	-	± 25 ppm/K; ± 15 ppm/K; ± 10 ppm/K
4.25.1	-	Endurance at 70 °C: precision operation mode	$U = \sqrt{P_{70}} \times R$ or $U = U_{max.}$; whichever is the less severe; 1.5 h on; 0.5 h off; 70 °C; 1000 h 70 °C; 8000 h	$\pm (0.05 \% R + 0.02 \Omega)$ $\pm (0.1 \% R + 0.02 \Omega)$	
		Endurance at 70 °C: standard operation mode	$U = \sqrt{P_{70}} \times R$ or $U = U_{max.}$; whichever is the less severe; 1.5 h on; 0.5 h off; 70 °C; 1000 h 70 °C; 8000 h	$\pm (0.1 \% R + 0.02 \Omega)$ $\pm (0.25 \% R + 0.05 \Omega)$	
4.25.3	-	Endurance at upper category temperature	85 °C; 1000 h	$\pm (0.1 \% R + 0.02 \Omega)$	$\pm (0.2 \% R + 0.02 \Omega)$
			125 °C; 1000 h	$\pm (0.2 \% R + 0.02 \Omega)$	$\pm (0.25 \% R + 0.05 \Omega)$
4.24	78 (Cab)	Damp heat, steady state	(40 $\pm$ 2) °C; 56 days; (93 $\pm$ 3) % RH	$\pm (0.1 \% R + 0.02 \Omega)$	$\pm (0.25 \% R + 0.05 \Omega)$

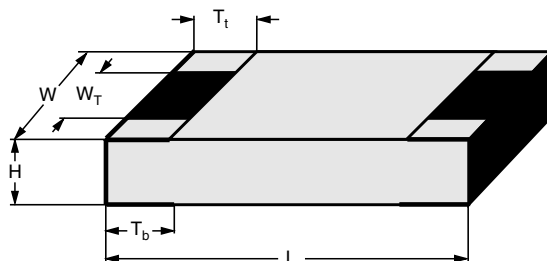


TEST PROCEDURES AND REQUIREMENTS					
EN 60115-1 CLAUSE	IEC 60068-2 (1) TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR)	
				STABILITY CLASS 0.1	STABILITY CLASS 0.25
			Stability for product types:		
			MCS 0402	100 Ω to 10 k Ω	> 10 k Ω to 221 k Ω
			MCT 0603	100 Ω to 10 k Ω	39 Ω to < 100 Ω ; > 10 k Ω to 511 k Ω
			MCU 0805	100 Ω to 47.5 k Ω	39 Ω to < 100 Ω ; > 47.5 k Ω to 1.5 M Ω
			MCA 1206	47 Ω to 332 k Ω	39 Ω to < 47 Ω ; > 332 k Ω to 2 M Ω
4.23		Climatic sequence: standard operation mode:			
4.23.2	2 (Bb)	Dry heat	125 °C; 16 h		
4.23.3	30 (Db)	Damp heat, cyclic	55 °C; 24 h; > 90 % RH; 1 cycle		
4.23.4	1 (Ab)	Cold	-55 °C; 2 h		
4.23.5	13 (M)	Low air pressure	8.5 kPa; 2 h; (25 $\pm$ 10) °C	$\pm (0.1 \% R + 0.02 \Omega)$	$\pm (0.25 \% R + 0.05 \Omega)$
4.23.6	30 (Db)	Damp heat, cyclic	55 °C; 24 h; > 90 % RH; 5 cycles		
4.23.7	-	DC load	$U = \sqrt{P_{70} \times R} \leq U_{max.};$ 1 min.		
-	1 (Aa)	Cold	-55 °C; 2 h	$\pm (0.05 \% R + 0.01 \Omega)$	
4.19	14 (Na)	Rapid change of temperature	30 min at LCT and 30 min at UCT; LCT = -10 °C; UCT = 85 °C; 5 cycles	$\pm (0.05 \% R + 0.01 \Omega)$ no visible damage	
			LCT = -55 °C; UCT = 125 °C; 1000 cycles	$\pm (0.25 \% R + 0.05 \Omega)$ no visible damage	
4.13	-	Short time overload: precision operation mode	$U = 2.5 \times \sqrt{P_{70} \times R}$ or $U = 2 \times U_{max.};$ whichever is the less severe; 5 s	$\pm (0.05 \% R + 0.01 \Omega)$	
		Short time overload: standard operation mode	$U = 2.5 \times \sqrt{P_{70} \times R}$ or $U = 2 \times U_{max.};$ whichever is the less severe; 5 s	$\pm (0.05 \% R + 0.01 \Omega)$	
4.27	-	Single pulse high voltage overload: standard operation mode	Severity no. 4: $U = 10 \times \sqrt{P_{70} \times R}$ or $U = 2 \times U_{max.};$ whichever is the less severe; 10 pulses 10 μ s/700 μ s	$\pm (0.5 \% R + 0.05 \Omega)$ no visible damage	
4.39	-	Periodic electric overload: standard operation mode	$U = \sqrt{15 \times P_{70} \times R}$ or $U = 2 \times U_{max.};$ whichever is the less severe; 0.1 s on; 2.5 s off; 1000 cycles	$\pm (0.5 \% R + 0.05 \Omega)$ no visible damage	

TEST PROCEDURES AND REQUIREMENTS					
EN 60115-1 CLAUSE	IEC 60068-2 ⁽¹⁾ TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR)	
				STABILITY CLASS 0.1	STABILITY CLASS 0.25
			Stability for product types:		
			MCS 0402	100 Ω to 10 k Ω	> 10 k Ω to 221 k Ω
			MCT 0603	100 Ω to 10 k Ω	39 Ω to < 100 Ω ; > 10 k Ω to 511 k Ω
			MCU 0805	100 Ω to 47.5 k Ω	39 Ω to < 100 Ω ; > 47.5 k Ω to 1.5 M Ω
			MCA 1206	47 Ω to 332 k Ω	39 Ω to < 47 Ω ; > 332 k Ω to 2 M Ω
4.38	-	Electro static discharge (human body model)	IEC 61340-3-1 ⁽¹⁾ ; 3 pos. + 3 neg. (equivalent to MIL-STD-883, method 3015) MCS 0402: 500 V MCT 0603: 1000 V MCU 0805: 1500 V MCA 1206: 2000 V	$\pm (0.5 \% R + 0.05 \Omega)$	
4.22	6 (Fc)	Vibration	Endurance by sweeping; 10 Hz to 2000 Hz; no resonance; amplitude ≤ 1.5 mm or ≤ 200 m/s ² ; 7.5 h	$\pm (0.05 \% R + 0.01 \Omega)$ no visible damage	
4.17	58 (Td)	Solderability	Solder bath method; SnPb40; non-activated flux; (215 $\pm$ 3) °C; (3 $\pm$ 0.3) s	Good tinning (≥ 95 % covered); no visible damage	
			Solder bath method; SnAg3Cu0.5 or SnAg3.5; non-activated flux; (235 $\pm$ 3) °C; (2 $\pm$ 0.2) s	Good tinning (≥ 95 % covered); no visible damage	
4.18	58 (Td)	Resistance to soldering heat	Solder bath method; (260 $\pm$ 5) °C; (10 $\pm$ 1) s	$\pm (0.05 \% R + 0.01 \Omega)$	
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol; + 50 °C; method 2	No visible damage	
4.32	21 (Ue ₃)	Shear (adhesion)	MCS 0402 and MCT 0603; 9 N	No visible damage	
			MCU 0805 and MCA 1206; 45 N	No visible damage	
4.33	21 (Ue ₁)	Substrate bending	Depth 2 mm, 3 times	$\pm (0.05 \% R + 0.01 \Omega)$ no visible damage, no open circuit in bent position	
4.7	-	Voltage proof	$U_{RMS} = U_{ins}$; (60 $\pm$ 5) s	No flashover or breakdown	
4.35	-	Flammability	IEC 60695-11-5 ⁽¹⁾ , needle flame test; 10 s	No burning after 30 s	

Note

⁽¹⁾ The quoted IEC standards are also released as EN standards with the same number and identical contents

**DIMENSIONS****DIMENSIONS AND MASS**

TYPE / SIZE	H (mm)	L (mm)	W (mm)	W _T (mm)	T _t (mm)	T _b (mm)	MASS (mg)
MCS 0402	0.32 ± 0.05	1.0 ± 0.05	0.5 ± 0.05	> 75 % of W	0.2 + 0.1 / - 0.15	0.2 ± 0.1	0.6
MCT 0603	0.45 + 0.1 / - 0.05	1.55 ± 0.05	0.85 ± 0.1	> 75 % of W	0.3 + 0.15 / - 0.2	0.3 + 0.15 / - 0.2	1.9
MCU 0805	0.45 + 0.1 / - 0.05	2.0 ± 0.1	1.25 ± 0.15	> 75 % of W	0.4 + 0.1 / - 0.2	0.4 + 0.1 / - 0.2	4.6
MCA 1206	0.55 ± 0.1	3.2 + 0.1 / - 0.2	1.6 ± 0.15	> 75 % of W	0.5 ± 0.25	0.5 ± 0.25	9.2

SOLDERING RECOMMENDATIONS

For recommended solder pad dimensions please refer to www.vishay.com/doc?28950.

For recommended soldering profiles please refer to www.vishay.com/doc?31090.

REVISION HISTORY

REVISION DATE	DESCRIPTION
29-Aug-2025	Update of RoHS status



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